



PRELIMINARY

SOLID STATE DEVICES, INC

14849 Firestone Boulevard · La Mirada, CA 90638
Phone: (714) 670-SSDI (7734) · Fax: (714) 522-7424

Designer's Data Sheet

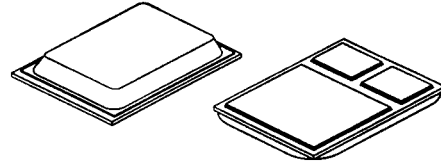
FEATURES:

- Rugged construction with polysilicon gate
- Low RDS(on) and high transconductance
- Excellent high temperature stability
- Very fast switching speed
- Fast recovery and superior dv/dt performance
- Increased reverse energy capability
- Low input and transfer capacitance for easy paralleling
- Ceramic Seals for improved hermeticity
- Hermetically sealed power surface mount package
- TX, TXV and Space Level screening available
- Replaces: IXTH50N20 Type

SFF50N20B

50 AMP 200 VOLTS 0.050 Ω N-CHANNEL POWER MOSFET

MILPACK 2



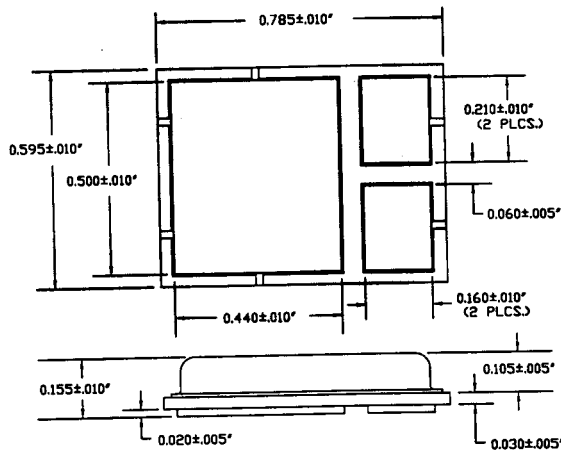
MAXIMUM RATINGS:

CHARACTERISTIC	SYMBOL	VALUE	UNIT
Drain to Source Voltage	V _{DS}	200	Volts
Gate to Source Voltage	V _{GS}	±20	Volts
Continuous Drain Current	I _D	50	Amps
Operating and Storage Temperature	T _{op} & T _{stg}	-55 to +150	°C
Thermal Resistance, Junction to Case	R _{θJC}	0.5	°C/W
Total Device Dissipation @ TC=25°C	P _D	250	Watts
Total Device Dissipation @ TC=55°C		190	

PACKAGE OUTLINE: MILPACK 2

PIN OUT:

- PIN 1: DRAIN
- PIN 2: SOURCE
- PIN 3: GATE



NOTE: All specifications are subject to change without notification. SCD's for these devices should be reviewed by SSDI prior to release.

DATA SHEET #: F00137 C

MED

SFF50N20B

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**SOLID STATE DEVICES, INC**14849 Firestone Boulevard · La Mirada, CA 90638
Phone: (714) 670-SSDI (7734) · Fax: (714) 522-7424**ELECTRICAL CHARACTERISTICS @ $T_J=25^\circ\text{C}$ (Unless Otherwise Specified)**

RATING		SYMBOL	MIN	TYP	MAX	UNIT
Drain to Source Breakdown Voltage (VGS=0 V, ID=250 μ A)		BVDSS	200	---	---	V
Drain to Source on State Resistance (VGS=10 V, ID=60% Rated ID)		RDS(on)	---	---	0.05	Ω
On State Drain Current (VDS > ID(on) X RDS(on) Max, VGS=10 V)		ID(on)	50	---	---	A
Gate Threshold Voltage (VDS=VGS, ID=4mA)		VGS(th)	2.0	---	4.0	V
Forward Transconductance (VDS > ID(on) X RDS(on) Max, IDS=50% rated ID)		gfs	20	25	---	S(τ)
Zero Gate Voltage Drain Current (VDS=max rated voltage, VGS=0 V) (VDS=80% rated VDS, VGS=0 V, TA=125°C)		IdSS	---	---	250 1000	μ A
Gate to Source Leakage Forward Gate to Source Leakage Reverse	At rated VGS	IgSS	---	---	+100 -100	nA
Total Gate Charge Gate to Source Charge Gate to Drain Charge	VGS=10 Volts 50% rated VDS 50% Rated ID	Qg Qgs Qgd	---	190 35 95	220 50 120	nC
Turn on Delay Time Rise Time Turn Off Delay Time Fall Time	VDD=50% rated VDS 50% rated ID RG= 6.2 Ω VGS=10V	td(on) tr td(off) tf	---	28 33 110 30	35 40 130 35	nsec
Diode Forward Voltage (IS=rated ID, VGS=0 V, TJ=25°C)		VSD	---	---	1.5	V
Diode Reverse Recovery Time Reverse Recovery Charge	TJ=25°C IF=10 A di/dt=100 A/ μ sec	trr QRR	---	---	225 ---	nsec μ C
Input Capacitance Output Capacitance Reverse Transfer Capacitance	VGS=0 Volts VDS=25 Volts f= 1 MHz	Ciss Coss Crss	---	4400 800 285	---	pF

For thermal derating curves and other characteristic curves please contact SSDI Marketing Department.